

# **Product Change Notification - LIAL-09YRLG884**

Date:

20 Aug 2018

**Product Category:** 

Touchscreen Controllers; Others; 32-bit Microcontrollers

**Affected CPNs:** 



### **Notification subject:**

CCB 3498 Initial Notice: Qualification of MMT as an additional assembly site for selected Atmel products of 66.11K, 66.15K, 66.26K wafer technology available in 100L TQFP (14x14x1mm) package.

**Notification text:** 

**PCN Status:** 

Initial notification

**PCN Type:** 

Manufacturing Change

# **Microchip Parts Affected:**

Please open one of the icons found in the Affected CPNs section above.

**NOTE:** For your convenience Microchip includes identical files in two formats (.pdf and .xls)

### **Description of Change:**

Qualification of MMT as an additional assembly site for selected Atmel products of 66.11K, 66.15K, 66.26K wafer technology available in 100L TQFP (14x14x1mm) package.

### **Pre Change:**

Assembled at ASE using PdCu or CuPdAu wire, CRM-1076WA die attach and G631H mold compound material.

### **Post Change:**

Assembled at ASE using PdCu or CuPdAu wire, CRM-1076WA die attach and G631H mold compound material or Assembled at MMT using CuPdAu wire, 3280 die attach and G700HA mold compound material.

**Pre and Post Change Summary:** 

	Pre C	hange	Post Change				
Assembly Site	ASE Inc. Ta	aiwan (ASE)	ASE Inc. Ta	Microchip Technology Thailand Branch (MMT)			
Wire material	PdCu	CuPdAu	PdCu	CuPdAu	CuPdAu		
Die attach material	CRM-1076WA		CRM-1	3280			
Molding compound material	G6	31H	G6	G700HA			
Lead frame material	C7	025					

Impacts to Data Sheet:



None

### **Change Impact:**

None

## Reason for Change:

To improve on-time delivery performance by qualifying MMT as an additional assembly site

# **Change Implementation Status:**

In Progress

# **Estimated Qualification Completion Date:**

November 2018

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

# **Time Table Summary:**

	August 2018				->	November 2018				
Workweek	31	32	33	34	35	->	45	46	47	48
Initial PCN Issue Date				X						
Qual Report Availability										X
Final PCN Issue Date										X

### **Method to Identify Change:**

Traceability code

#### **Qualification Plan:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual Plan.

### **Revision History:**

August 20, 2018: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

### Attachment(s):

PCN LIAL-09YRLG884 QUAL PLAN.pdf

Please contact your local <u>Microchip sales office</u> with questions or concerns regarding this notification.

# **Terms and Conditions:**

If you wish to change your product/process change notification (PCN) profile please log on to our website at <a href="http://www.microchip.com/PCN">http://www.microchip.com/PCN</a> sign into myMICROCHIP to open the myMICROCHIP



home page, then select a profile option from the left navigation bar.

To opt out of future offer or information emails (other than product change notification emails), click here to go to <a href="mailto:microchipDIRECT">microchipDIRECT</a> and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's products or services."

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#### Affected Catalog Part Numbers (CPN)

ATMXT225T-AB

ATMXT225T-ABR

ATMXT225T-AT

ATMXT225T-ATR

ATMXT225T-ATRV05

ATMXT225TD-AB

ATMXT225TD-ABR

ATMXT225TD-AT

ATMXT225TD-ATR

ATMXT449T-AB

ATMXT449T-AB074

ATMXT449T-ABR

ATMXT449T-ABR074

ATMXT449T-AT

ATMXT449T-AT066

ATMXT449T-AT074

ATMXT449T-ATNBI

ATMXT449T-ATR

ATMXT449T-ATR066

ATMXT449T-ATR074

ATMXT449T-ATRNBI

ATMXT449T-ATRV02

ATMXT449T-ATV03

ATMXT449TD-AB

ATMXT449TD-ABR

ATMXT449TD-AT

ATMXT449TD-ATR

ATMXT641T-AB

ATMXT641T-AB074

ATMXT641T-ABR

ATMXT641T-ABR074

ATMXT641T-AT

ATMXT641T-AT064

ATMXT641T-AT074

ATMXT641T-ATNBI

ATMXT641T-ATR

ATMXT641T-ATR064

ATMXT641T-ATR074

ATMXT641T-ATRNBI

ATMXT641T-ATRV01

ATMXT641TC01-AT

ATMXT641TC01-ATR

ATMXT641TD-AB

ATMXT641TD-ABR

ATMXT641TD-ABRV04

ATMXT641TD-ABRV06

Date: Sunday, August 19, 2018

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ATMXT641TD-ATRV07

ATMXT641TH-AT

ATMXT641TH-ATR

ATSAMC20N17A-ANT

ATSAMC20N18A-ANT

ATSAMC21N17A-ANT

ATSAMC21N18A-ANT ATSAML22N16A-AUT

ATSAML22N17A-AUT

ATSAML22N18A-AUT

Date: Sunday, August 19, 2018